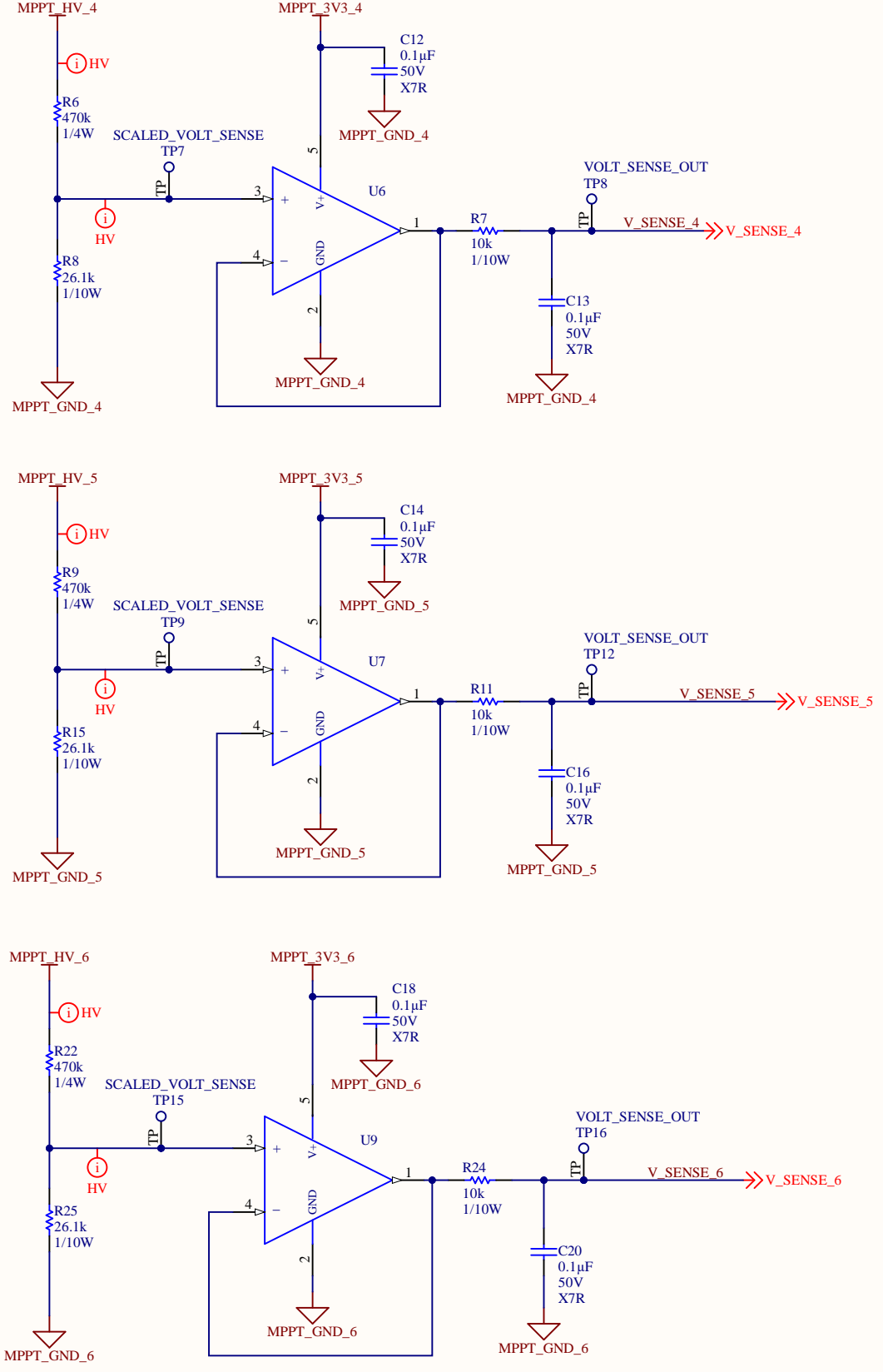
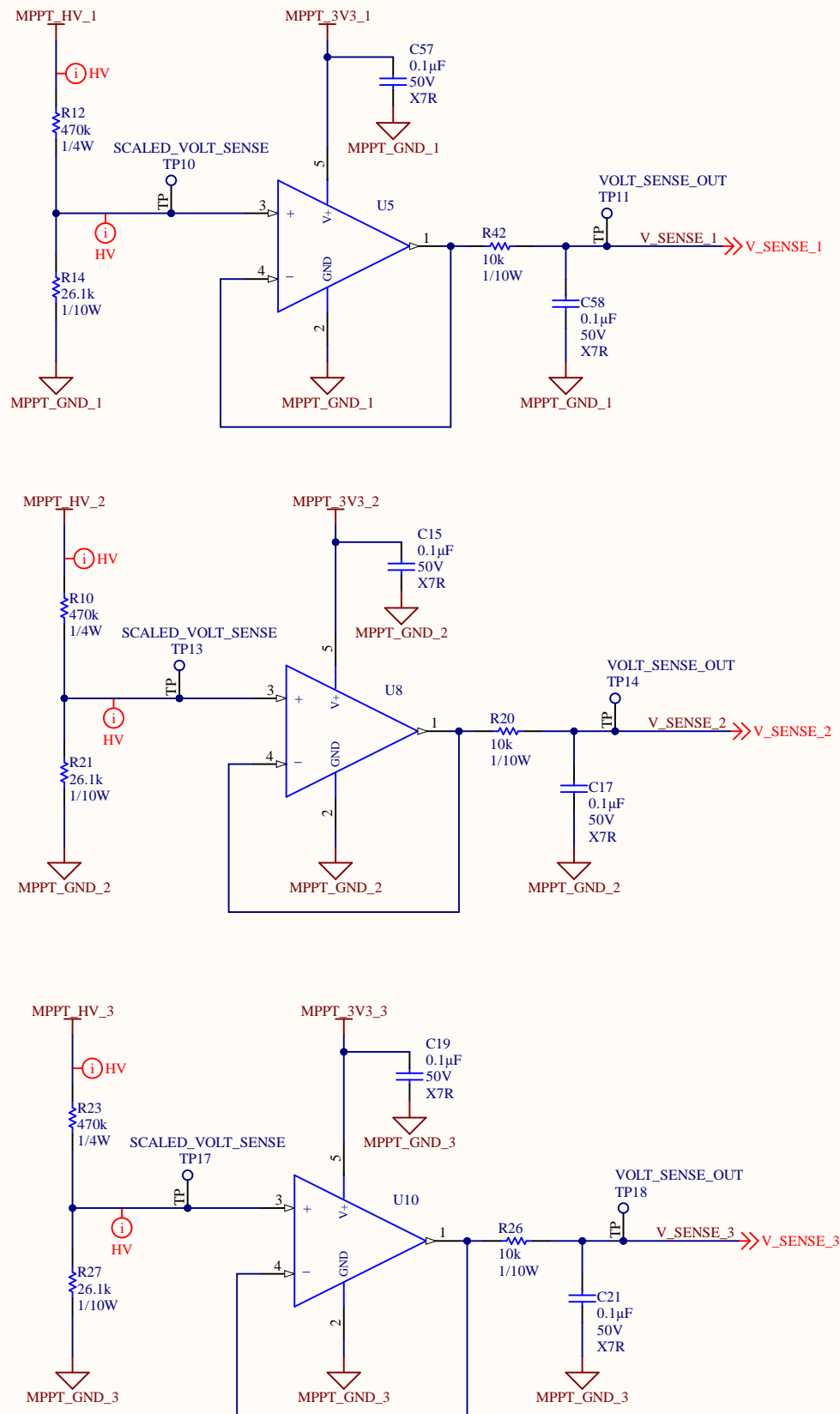
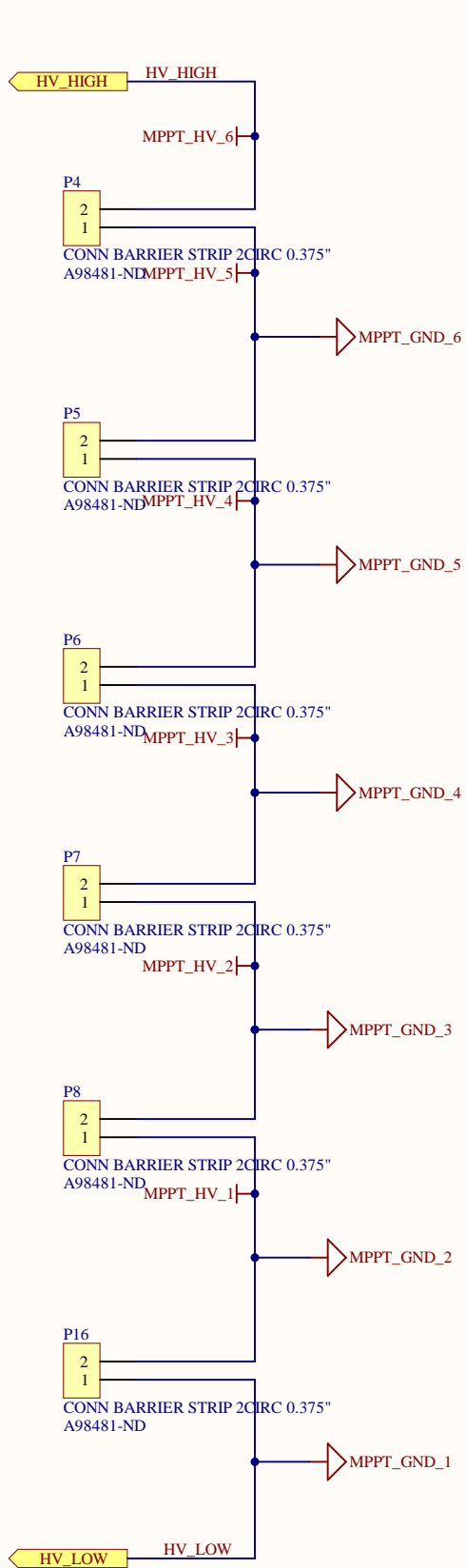
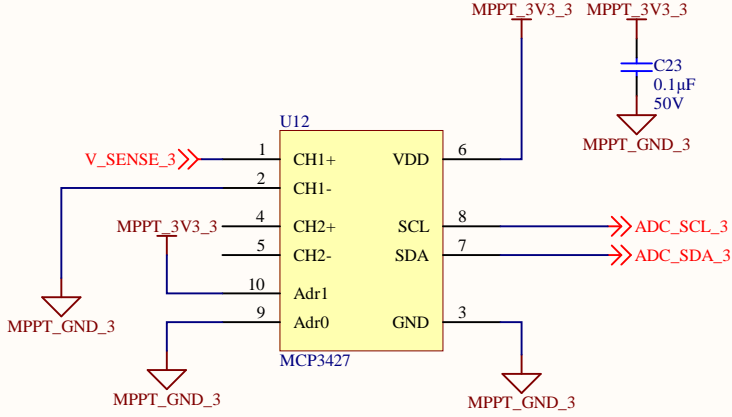
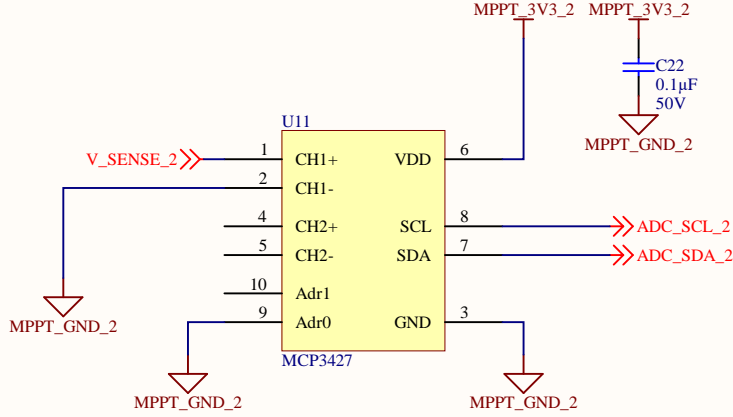
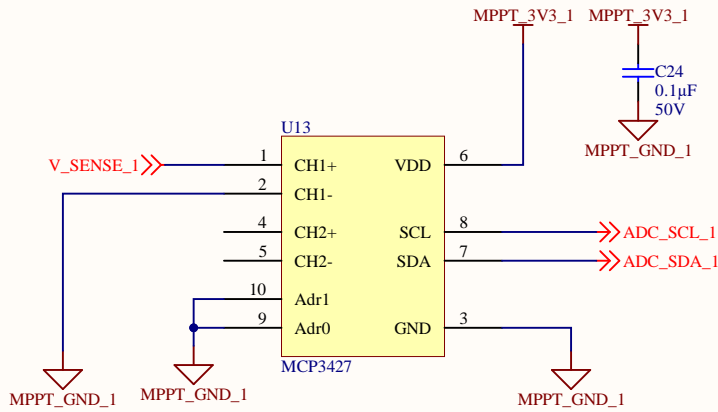


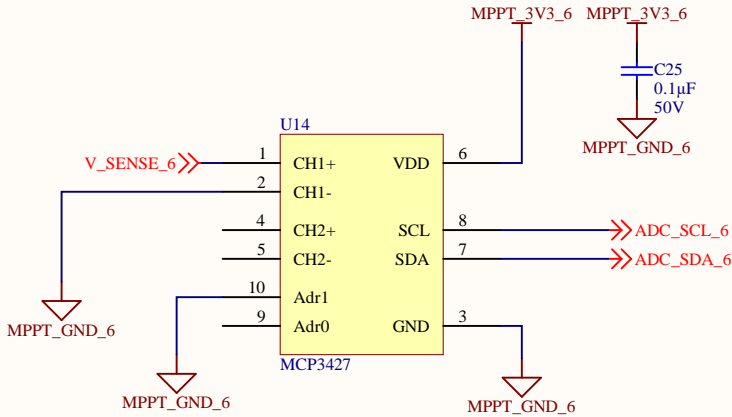
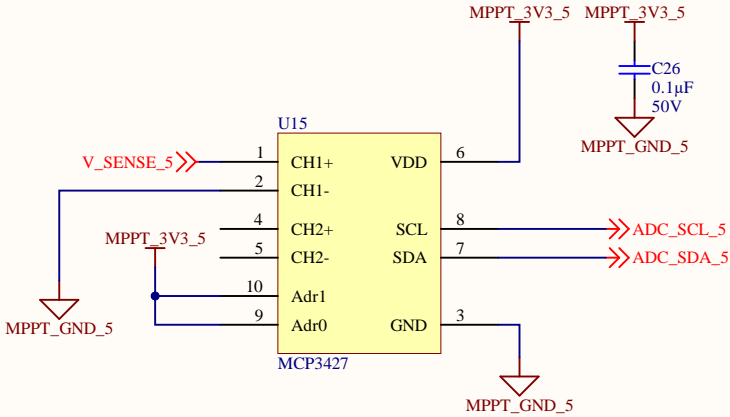
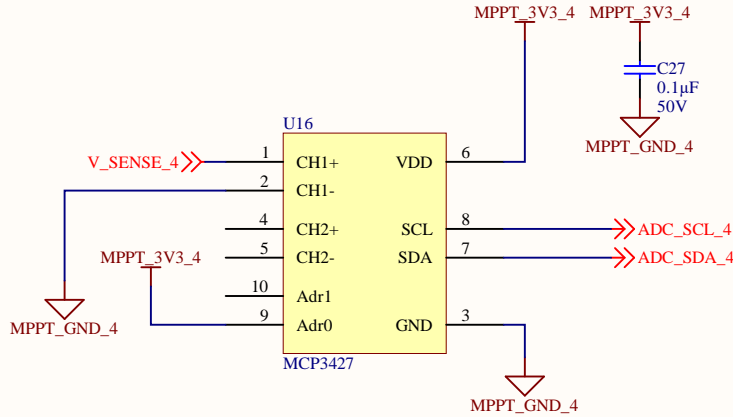
Voltage Sense





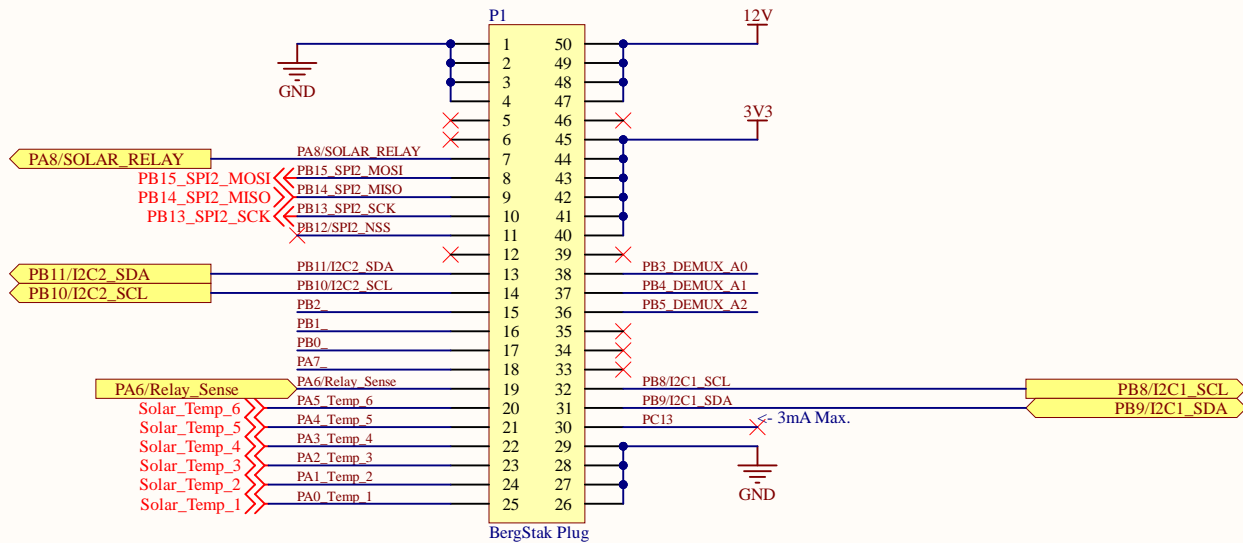
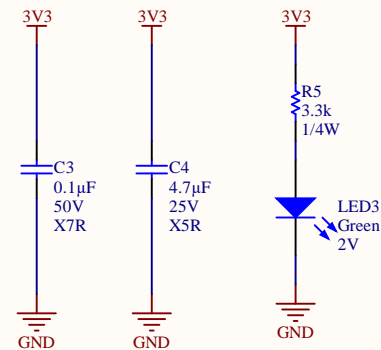
ADCs

I ² C Device Address Bits			Logic Status of Address Selection Pins	
A2	A1	A0	Adr0 Pin	Adr1 Pin
0	0	0	0 (Addr_Low)	0 (Addr_Low)
0	0	1	0 (Addr_Low)	Float
0	1	0	0 (Addr_Low)	1 (Addr_High)
1	0	0	1 (Addr_High)	0 (Addr_Low)
1	0	1	1 (Addr_High)	Float
1	1	0	1 (Addr_High)	1 (Addr_High)
0	1	1	Float	0 (Addr_Low)
1	1	1	Float	1 (Addr_High)
0	0	0	Float	Float

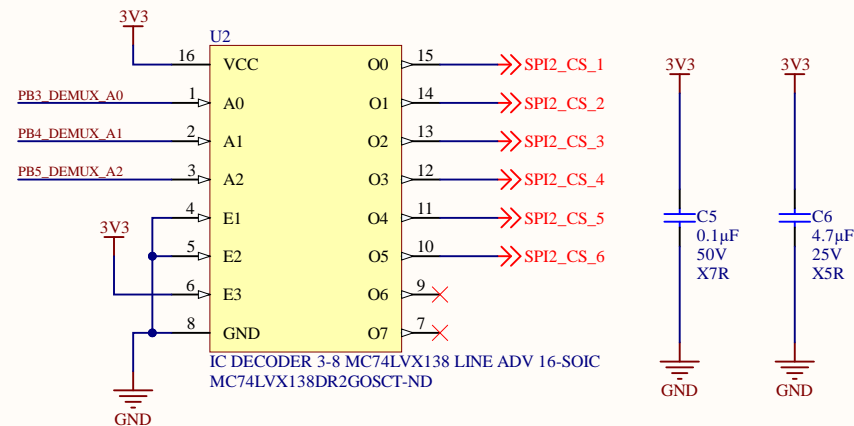
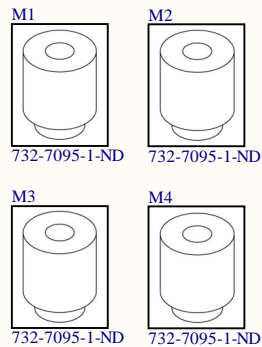



Make combination of pulled high, low and floating (for address pins)

Add 6 gpio pins for slave select on spi, and 6 gpios for temperature sensing

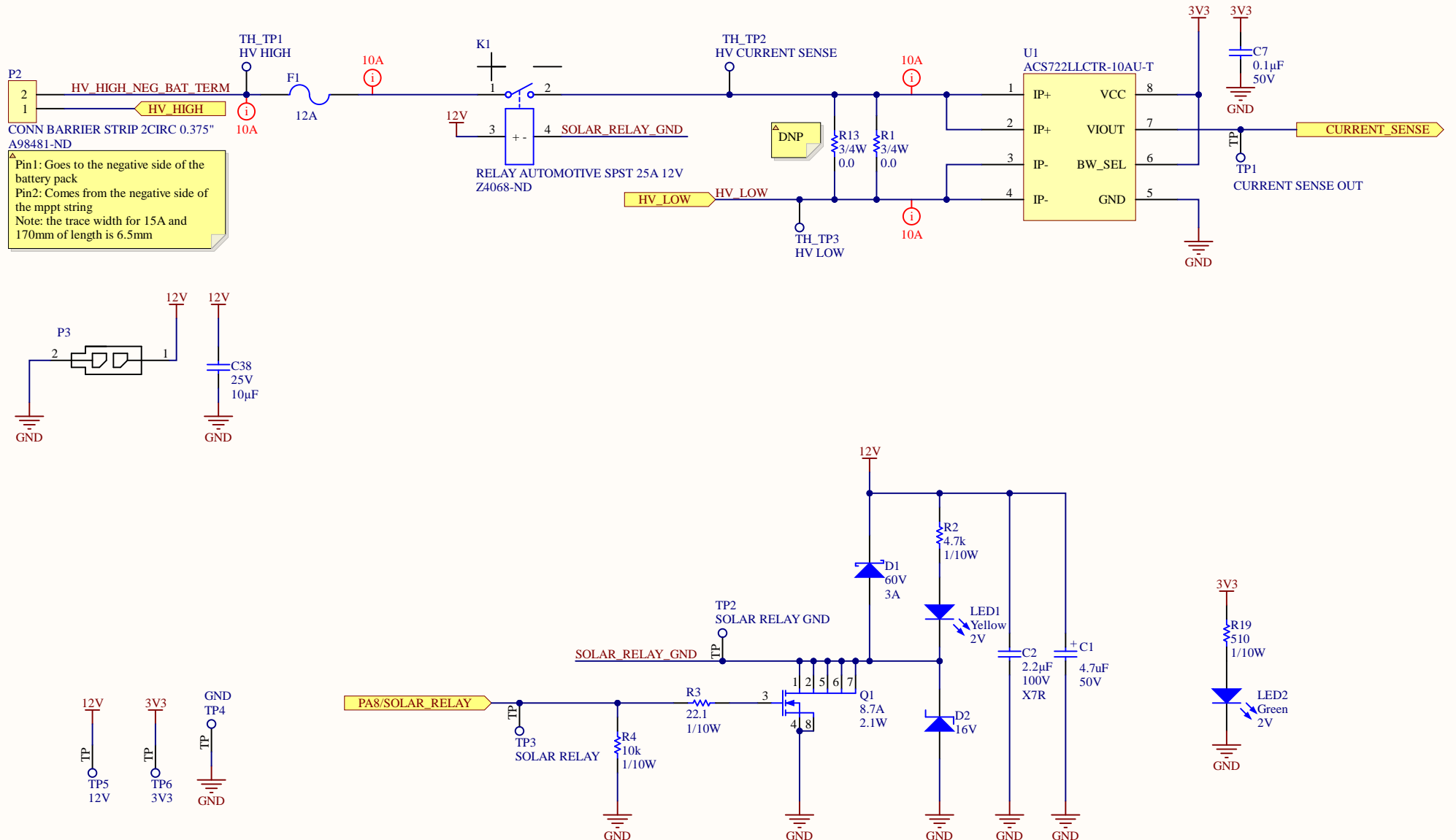



Standoffs



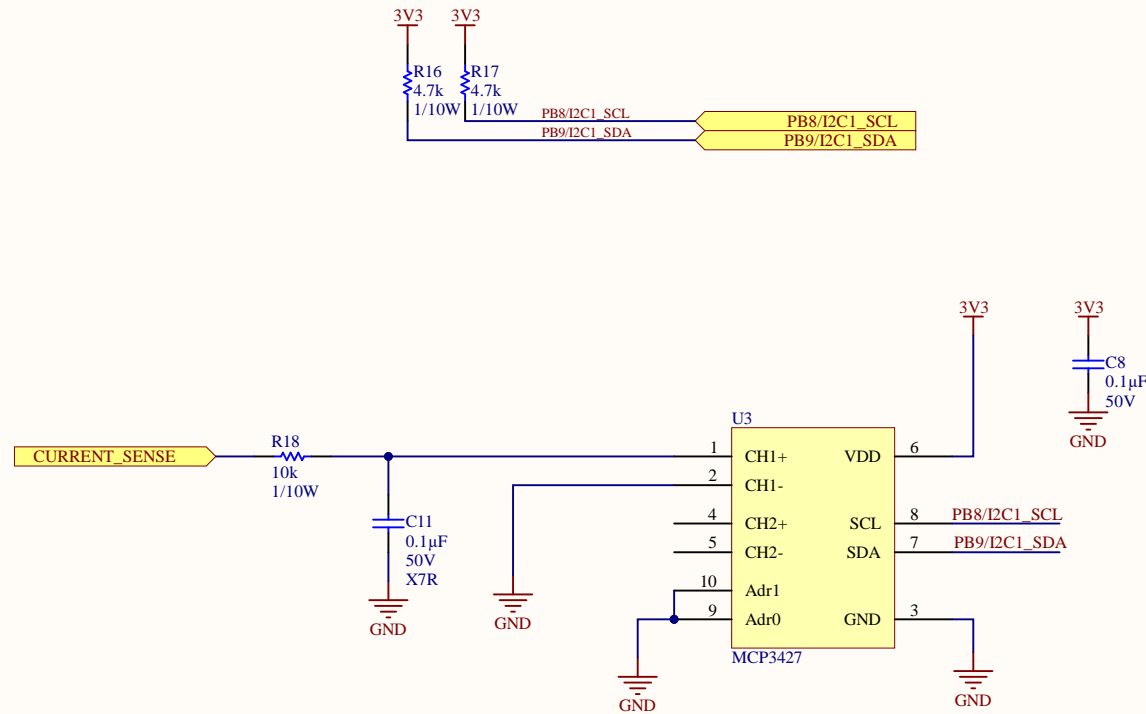
Project: <i>MSXIV_SolarSense.PrjPcb</i>		<div><div>MIDNIGHT</div><div></div><div>SUN</div></div>
Title: *		
Project AuthorAashmika Mali		University of Waterloo 200 University Ave W Waterloo, ON, Canada N2L 3E9
Size: Letter	Revision: 1.0	
Date: 2020-02-09	Sheet * of *	
		Website: www.uwmidsun.com

Passthrough - Current Sense, Fuse, and Relay



Project: <i>MSXIV_SolarSense.PrjPcb</i>		
Title: <i>*</i>		
Project Author: <i>Aashmika Mali</i>		University of Waterloo 200 University Ave W Waterloo, ON, Canada N2L 3E9
Size: <i>Letter</i>	Revision: <i>1.0</i>	
Date: <i>2020-02-09</i>	Sheet* of *	
		Website: <i>www.uwmid.sun.com</i>

I2C Interface (for Current Sense)



Project: **MSXIV_SolarSense.PrjPcb**

Title: *

Project Author: **Aashmika Mali**

Size: **Letter**

Date: **2020-02-09**

Revision: **1.0**

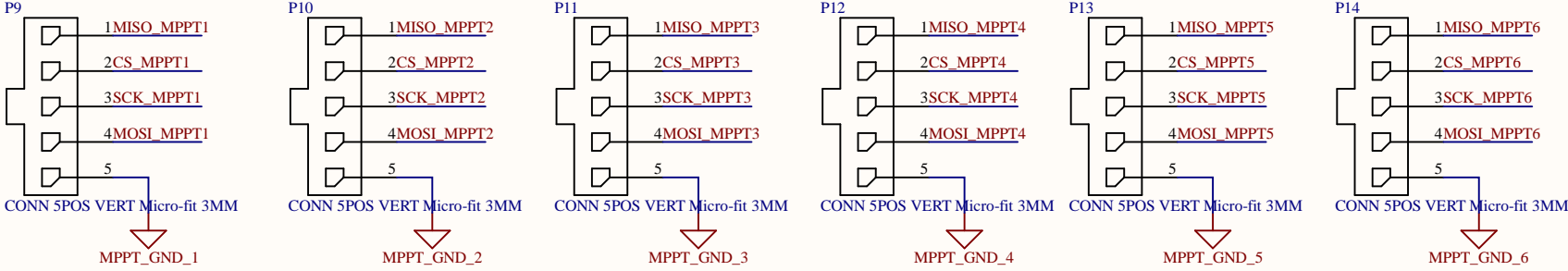
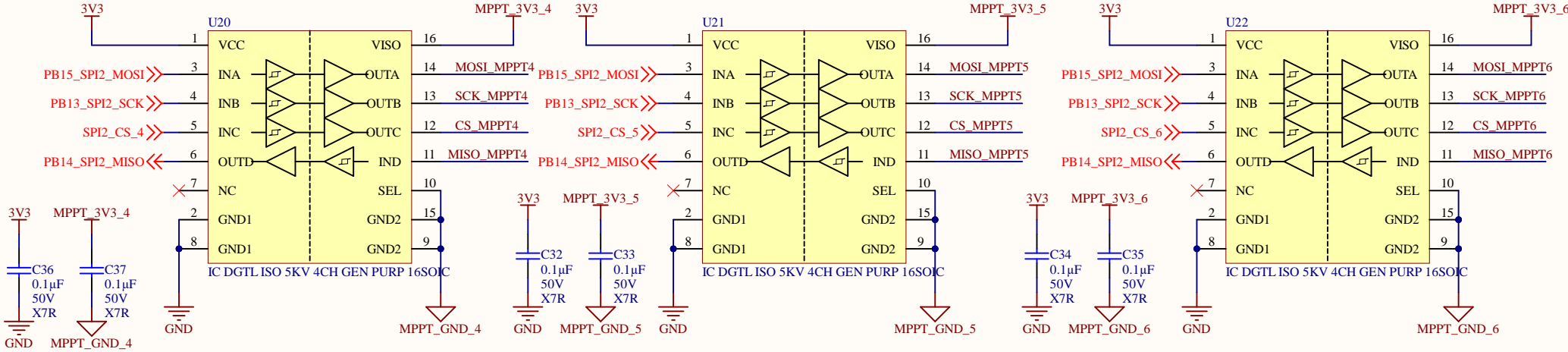
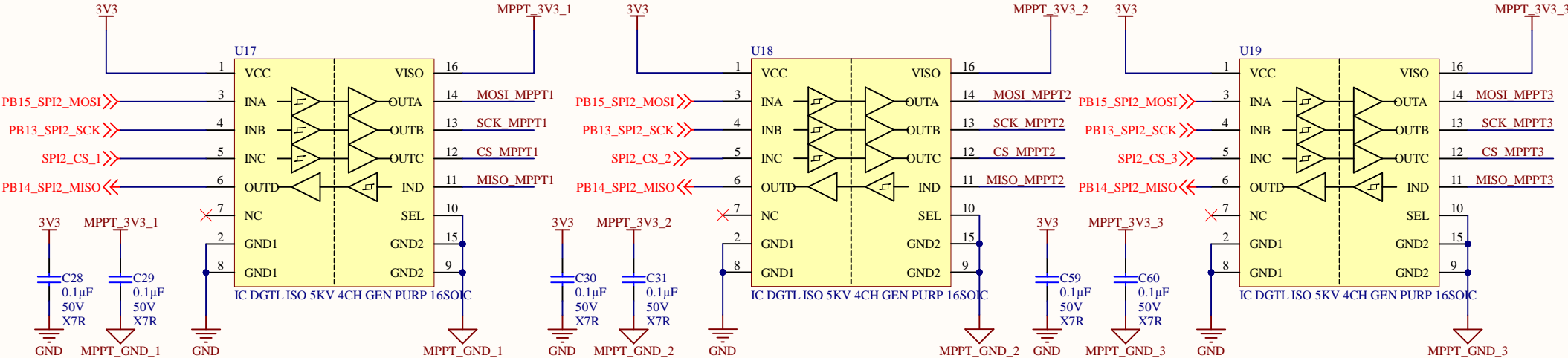
Sheet * of *



University of Waterloo
200 University Ave W
Waterloo, ON, Canada
N2L 3E9

Website: www.uwmidsun.com

SPI Isolators



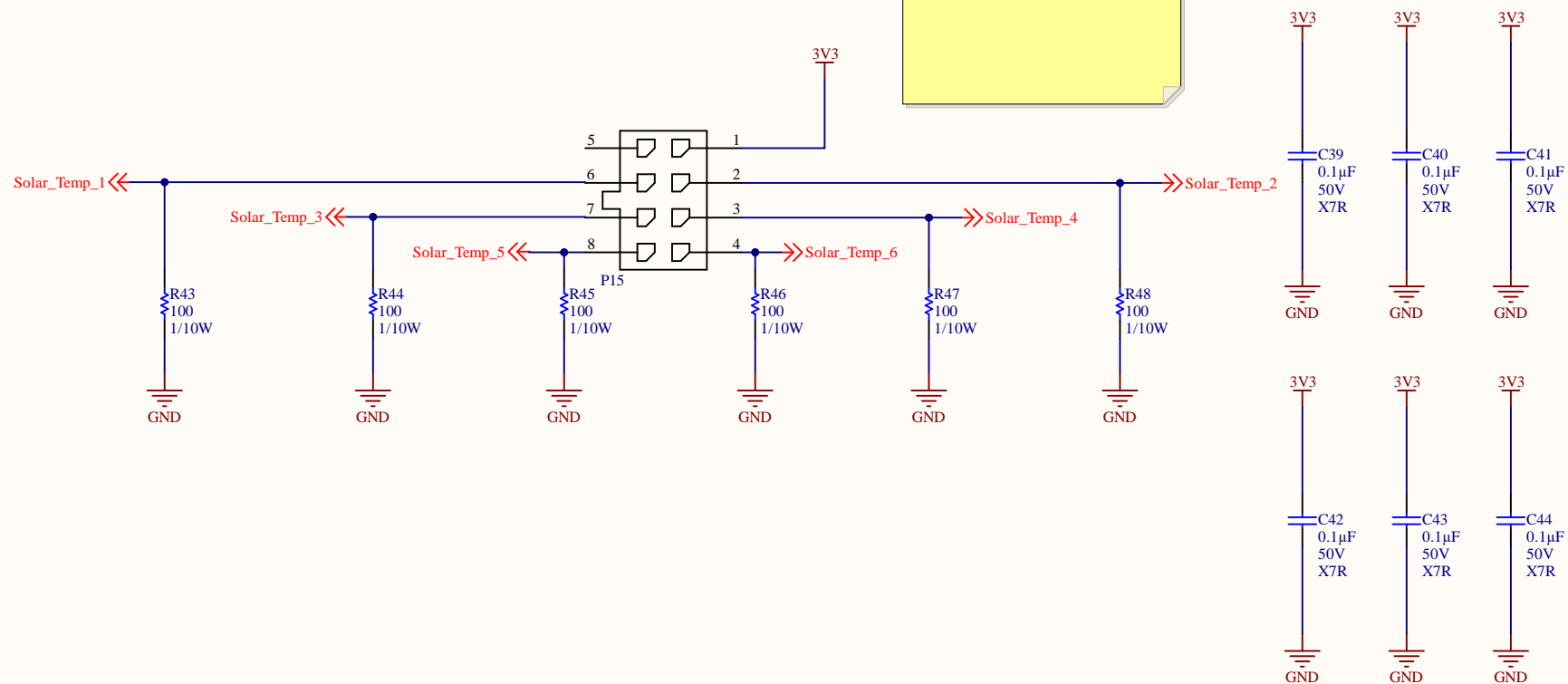
PROJECT	MSXIV_SolarSense.PrjPcb		
DOCUMENT	*		
PART NUMBER	VARIANT	[No Variations]	
DRAWN BY	Aashmika Mali	REVISION	1.0
LAST MODIFIED	2020-02-09	SHEET	* OF *


MIDNIGHT

SUN

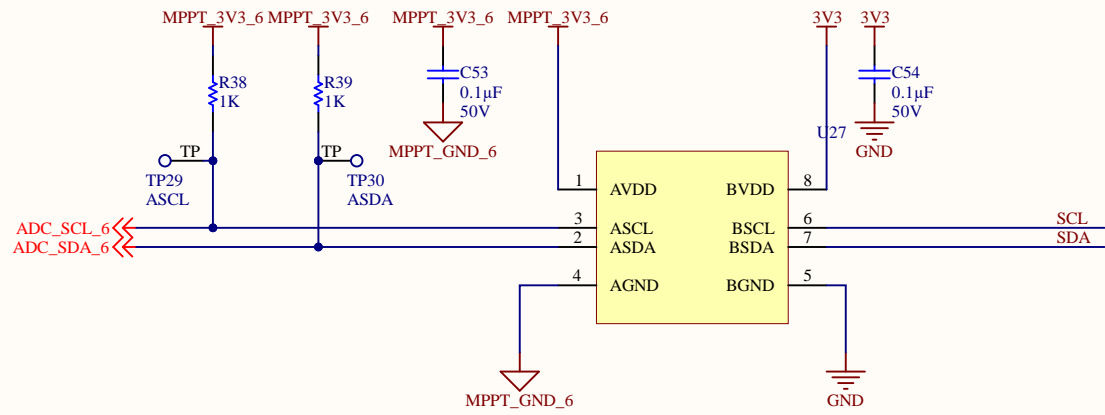
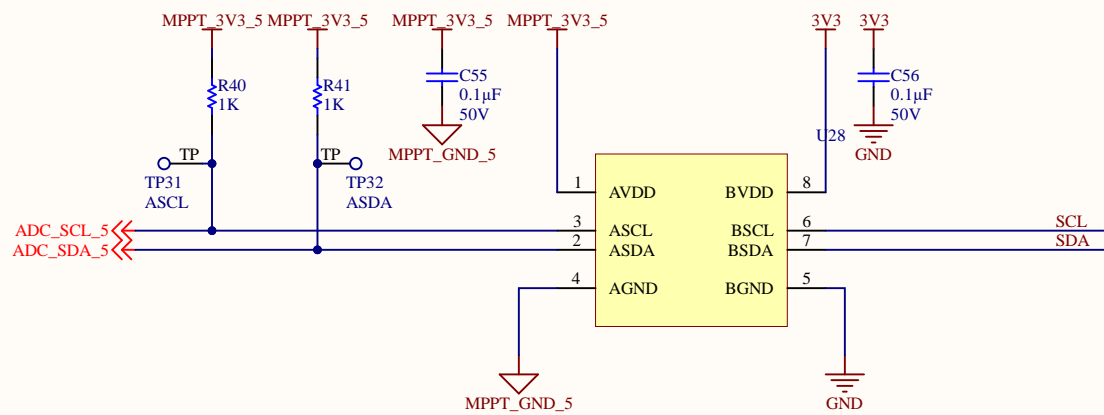
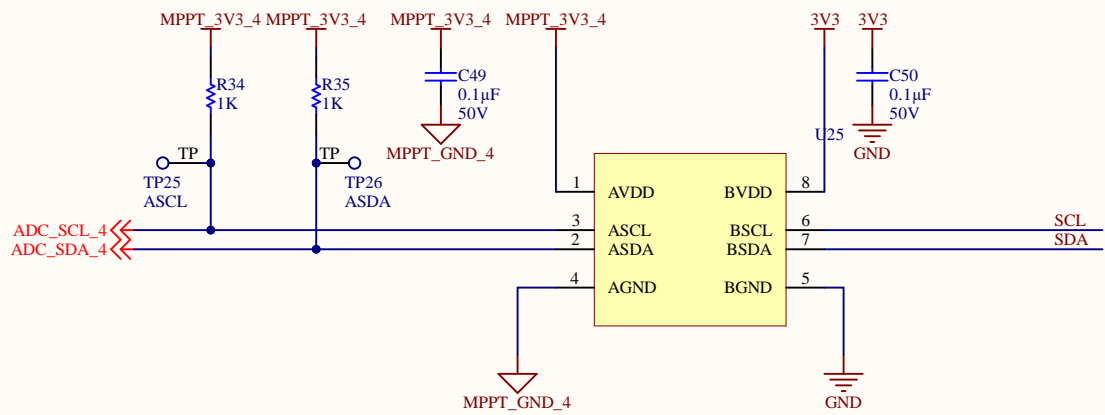
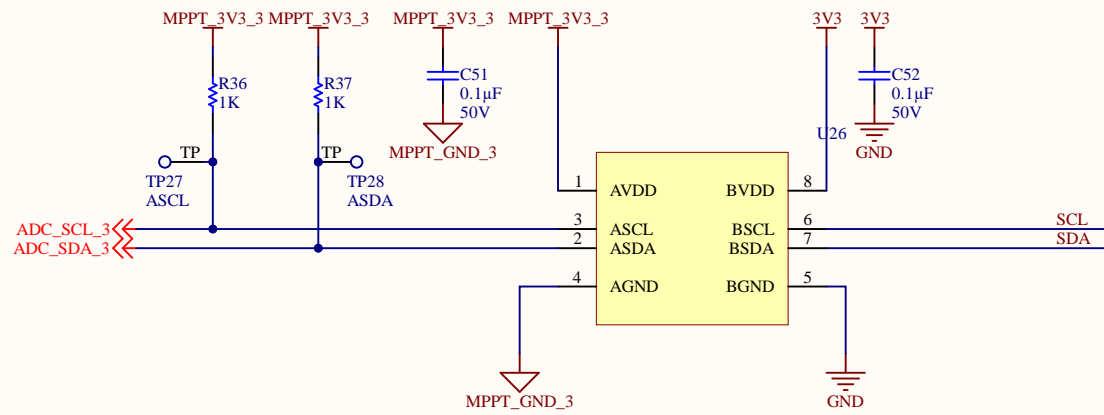
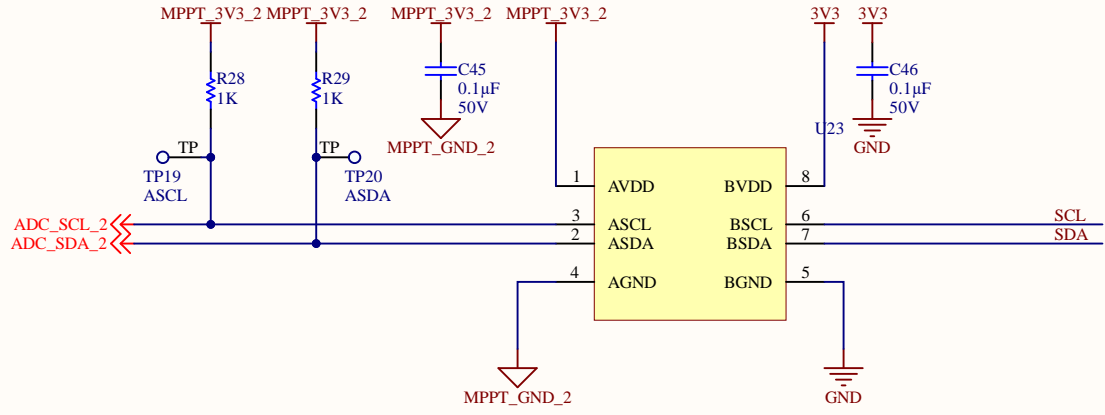
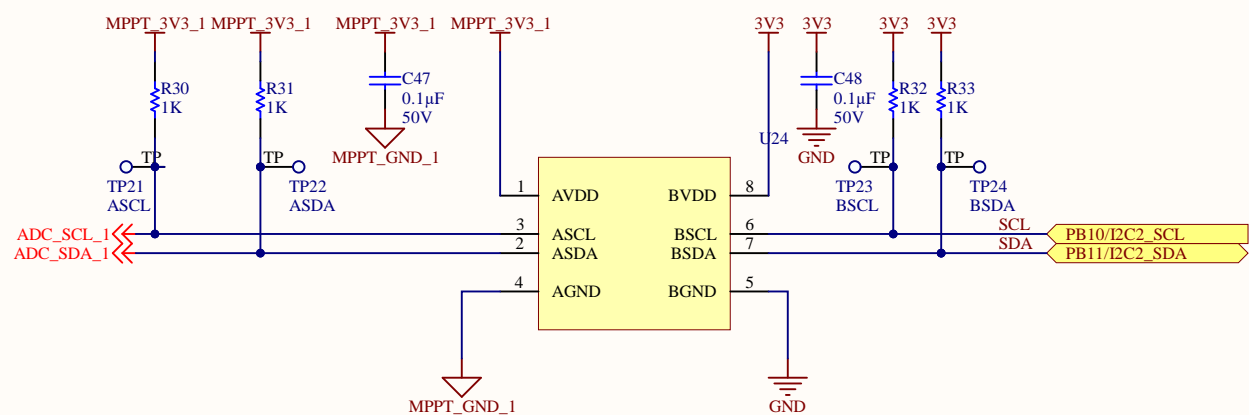
Engineering 5 - 1002
University of Waterloo
(519) 888-4567 x32978
hardware@uwmidsun.com

△ To thermistors on solar sections



Project: <i>MSXIV_SolarSense.PrjPcb</i>		
Title: *		
Project Author: Aashmika Mali		University of Waterloo 200 University Ave W Waterloo, ON, Canada N2L 3E9 Website: www.uwmidsun.com
Size: Letter	Revision: 1.0	
Date: 2020-02-09	Sheet * of *	

I2C Isolators for V-Sense



PROJECT		MSXIV_SolarSense.PrjPcb	
DOCUMENT		*	
PART NUMBER	VARIANT	[No Variations]	
DRAWN BY	REVISION	Aashmika Mali 1.0	
LAST MODIFIED	SHEET	2020-02-09 * OF *	

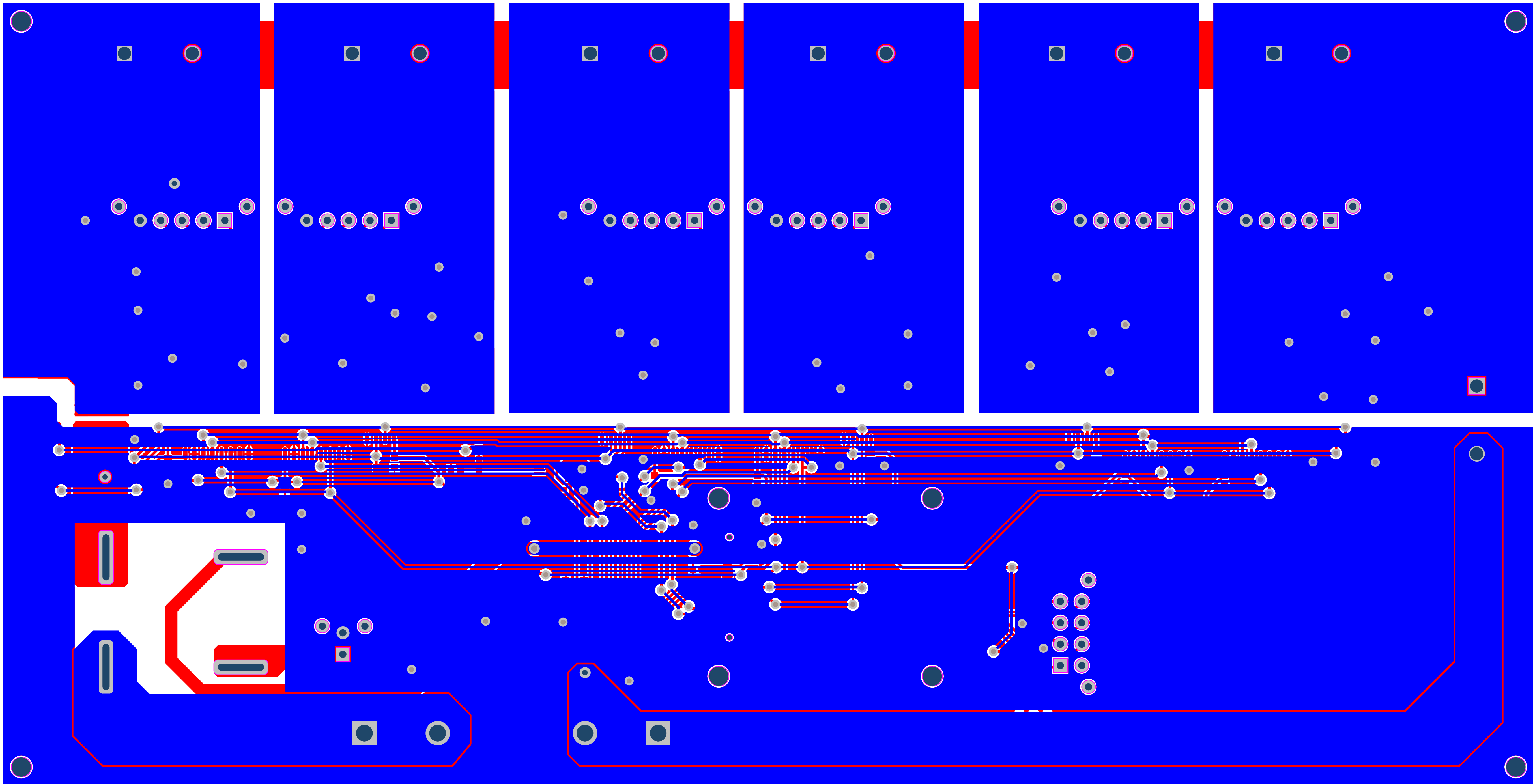
MIDNIGHT

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University of Waterloo
(519) 888-4567 x32978
hardware@uwmidsun.com

[illegible]





Electrical Rules Check Report

[illegible]

Class	Document	Message
Warning	Controller_Board_Interface.SchDoc	Nets Wire PA2_Temp_3 has multiple names (Cross-Sheet Connector Solar_Temp_3, Cross-Sheet Connector Solar_Temp_3, Net Label PA2_Temp_3)
Warning	Controller_Board_Interface.SchDoc	Nets Wire PA3_Temp_4 has multiple names (Cross-Sheet Connector Solar_Temp_4, Cross-Sheet Connector Solar_Temp_4, Net Label PA3_Temp_4)
Warning	Controller_Board_Interface.SchDoc	Nets Wire PA4_Temp_5 has multiple names (Cross-Sheet Connector Solar_Temp_5, Cross-Sheet Connector Solar_Temp_5, Net Label PA4_Temp_5)
Warning	Controller_Board_Interface.SchDoc	Nets Wire PA5_Temp_6 has multiple names (Cross-Sheet Connector Solar_Temp_6, Cross-Sheet Connector Solar_Temp_6, Net Label PA5_Temp_6)
Warning	Controller_Board_Interface.SchDoc	Nets Wire PB10/I2C2_SCL has multiple names (Net Label PB10/I2C2_SCL, Net Label SCL, Net Label SCL, Net Label SCL, Net Label SCL, Net Label SCL)
Warning	Controller_Board_Interface.SchDoc	Nets Wire PB11/I2C2_SDA has multiple names (Net Label PB11/I2C2_SDA, Net Label SDA, Net Label SDA, Net Label SDA, Net Label SDA, Net Label SDA)
Warning	ADCs.SchDoc	Off grid C24 at 3818.11mil,8674.41mil
Warning	ADCs.SchDoc	Off grid Cross-Sheet Connector ADC_SCL_1 at 3600mil,7694.41mil
Warning	ADCs.SchDoc	Off grid Cross-Sheet Connector ADC_SDA_1 at 3600mil,7544.41mil
Warning	SPI_Interface.SchDoc	Off grid Cross-Sheet Connector PB13_SPI2_SCK at 6574.41mil,6651.811mil
Warning	SPI_Interface.SchDoc	Off grid Cross-Sheet Connector PB14_SPI2_MISO at 6574.41mil,6251.811mil
Warning	SPI_Interface.SchDoc	Off grid Cross-Sheet Connector PB15_SPI2_MOSI at 6574.41mil,6851.811mil
Warning	TemperatureSense.SchDoc	Off grid Cross-Sheet Connector Solar_Temp_2 at 7837.008mil,4796.063mil
Warning	TemperatureSense.SchDoc	Off grid Cross-Sheet Connector Solar_Temp_4 at 6687.008mil,4596.063mil
Warning	Controller_Board_Interface.SchDoc	Off grid Cross-Sheet Connector Solar_Temp_6 at 2247.008mil,4300mil
Warning	TemperatureSense.SchDoc	Off grid Cross-Sheet Connector Solar_Temp_6 at 5650mil,4396.063mil
Warning	ADCs.SchDoc	Off grid Cross-Sheet Connector V_SENSE_1 at 1350mil,8044.41mil
Warning	ADCs.SchDoc	Off grid Cross-Sheet Connector V_SENSE_2 at 6281.89mil,8100mil
Warning	ADCs.SchDoc	Off grid Cross-Sheet Connector V_SENSE_3 at 11381.89mil,8100mil
Warning	ADCs.SchDoc	Off grid Cross-Sheet Connector V_SENSE_4 at 1631.89mil,3500mil
Warning	ADCs.SchDoc	Off grid Cross-Sheet Connector V_SENSE_5 at 6531.89mil,3500mil
Warning	ADCs.SchDoc	Off grid Cross-Sheet Connector V_SENSE_6 at 11231.89mil,3400mil
Warning	Controller_Board_Interface.SchDoc	Off grid M1 at 1693.983mil,2899.713mil
Warning	Controller_Board_Interface.SchDoc	Off grid M2 at 2406.601mil,2898.306mil
Warning	Controller_Board_Interface.SchDoc	Off grid M3 at 1693.983mil,1949.714mil
Warning	Controller_Board_Interface.SchDoc	Off grid M4 at 2406.601mil,1948.306mil
Warning	SPI_Interface.SchDoc	Off grid Net Label CS_MPPT2 at 8674.41mil,6451.811mil
Warning	SPI_Interface.SchDoc	Off grid Net Label MISO_MPPT2 at 8624.41mil,6251.811mil
Warning	SPI_Interface.SchDoc	Off grid Net Label MISO_MPPT3 at 12055.512mil,6250mil
Warning	SPI_Interface.SchDoc	Off grid Net Label MOSI_MPPT2 at 8674.41mil,6851.811mil
Warning	SPI_Interface.SchDoc	Off grid Net Label MOSI_MPPT3 at 12055.512mil,6850mil
Warning	SPI_Interface.SchDoc	Off grid Net Label SCK_MPPT2 at 8674.41mil,6651.811mil
Warning	SPI_Interface.SchDoc	Off grid No ERC at 6774.41mil,6051.811mil
Warning	TemperatureSense.SchDoc	Off grid P15 at 4521.654mil,5096.063mil
Warning	ADCs.SchDoc	Off grid Pin C24-1 at 3818.11mil,8674.41mil
Warning	ADCs.SchDoc	Off grid Pin C24-2 at 3818.11mil,8374.41mil
Warning	TemperatureSense.SchDoc	Off grid Pin P15-1 at 5421.654mil,4996.063mil
Warning	TemperatureSense.SchDoc	Off grid Pin P15-2 at 5421.654mil,4796.063mil
Warning	TemperatureSense.SchDoc	Off grid Pin P15-3 at 5421.654mil,4596.063mil
Warning	TemperatureSense.SchDoc	Off grid Pin P15-4 at 5421.654mil,4396.063mil
Warning	TemperatureSense.SchDoc	Off grid Pin P15-5 at 4521.654mil,4996.063mil
Warning	TemperatureSense.SchDoc	Off grid Pin P15-6 at 4521.654mil,4796.063mil
Warning	TemperatureSense.SchDoc	Off grid Pin P15-7 at 4521.654mil,4596.063mil
Warning	TemperatureSense.SchDoc	Off grid Pin P15-8 at 4521.654mil,4396.063mil
Warning	ADCs.SchDoc	Off grid Pin U13-1 at 1658.11mil,8044.41mil
Warning	ADCs.SchDoc	Off grid Pin U13-2 at 1658.11mil,7894.41mil
Warning	ADCs.SchDoc	Off grid Pin U13-3 at 3108.11mil,7194.41mil
Warning	ADCs.SchDoc	Off grid Pin U13-4 at 1658.11mil,7694.41mil
Warning	ADCs.SchDoc	Off grid Pin U13-5 at 1658.11mil,7544.41mil
Warning	ADCs.SchDoc	Off grid Pin U13-6 at 3108.11mil,8044.41mil
Warning	ADCs.SchDoc	Off grid Pin U13-7 at 3108.11mil,7544.41mil
Warning	ADCs.SchDoc	Off grid Pin U13-8 at 3108.11mil,7694.41mil
Warning	ADCs.SchDoc	Off grid Pin U13-9 at 1658.11mil,7194.41mil
Warning	ADCs.SchDoc	Off grid Pin U13-10 at 1658.11mil,7344.41mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-1 at 6774.41mil,7051.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-2 at 6774.41mil,5851.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-3 at 6774.41mil,6851.811mil

Class	Document	Message
Warning	SPI_Interface.SchDoc	Off grid Pin U18-4 at 6774.41mil,6651.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-5 at 6774.41mil,6451.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-6 at 6774.41mil,6251.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-7 at 6774.41mil,6051.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-8 at 6774.41mil,5651.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-9 at 8574.41mil,5651.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-10 at 8574.41mil,6051.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-11 at 8574.41mil,6251.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-12 at 8574.41mil,6451.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-13 at 8574.41mil,6651.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-14 at 8574.41mil,6851.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-15 at 8574.41mil,5851.811mil
Warning	SPI_Interface.SchDoc	Off grid Pin U18-16 at 8574.41mil,7051.811mil
Warning	TemperatureSense.SchDoc	Off grid Power Object 3V3 at 5899.606mil,5389.764mil
Warning	SPI_Interface.SchDoc	Off grid Power Object 3V3 at 6174.41mil,7351.811mil
Warning	SPI_Interface.SchDoc	Off grid Power Object GND at 6774.41mil,5351.811mil
Warning	ADCs.SchDoc	Off grid Power Object MPPT_3V3_1 at 3218.11mil,8674.41mil
Warning	ADCs.SchDoc	Off grid Power Object MPPT_3V3_1 at 3818.11mil,8674.41mil
Warning	SPI_Interface.SchDoc	Off grid Power Object MPPT_3V3_2 at 9074.41mil,7351.811mil
Warning	ADCs.SchDoc	Off grid Power Object MPPT_GND_1 at 818.11mil,7074.41mil
Warning	ADCs.SchDoc	Off grid Power Object MPPT_GND_1 at 3468.11mil,7074.41mil
Warning	ADCs.SchDoc	Off grid Power Object MPPT_GND_1 at 3818.11mil,8374.41mil
Warning	SPI_Interface.SchDoc	Off grid Power Object MPPT_GND_2 at 8574.41mil,5351.811mil
Warning	ADCs.SchDoc	Off grid U13 at 1958.11mil,8194.41mil
Warning	SPI_Interface.SchDoc	Off grid U18 at 7474.41mil,6651.811mil

Design Rules Verification Report

Filename : C:\Users\Aashmika Mali\Documents\First Year\Midnight Sun\hardware\MSXIV_

Warnings 0
Rule Violations 127

Warnings	
Total	0

Rule Violations	
Clearance Constraint (Gap=10mil) (All),(All)	0
Short-Circuit Constraint (Allowed=No) (All),(All)	0
Un-Routed Net Constraint ((All))	0
Modified Polygon (Allow modified: No), (Allow shelved: No)	0
Width Constraint (Min=10mil) (Max=70mil) (Preferred=15mil) (All)	0
Power Plane Connect Rule(Direct Connect)(Expansion=20mil) (Conductor Width=10mil) (Air Gap=10mil) (Entries=4,	0
Hole Size Constraint (Min=1mil) (Max=100mil) (All)	12
Hole To Hole Clearance (Gap=10mil) (All),(All)	0
Minimum Solder Mask Sliver (Gap=10mil) (All),(All)	27
Silk To Solder Mask (Clearance=10mil) (IsPad),(All)	77
Silk to Silk (Clearance=10mil) (All),(All)	11
Net Antennae (Tolerance=0mil) (All)	0
Height Constraint (Min=0mil) (Max=1000mil) (Preferred=500mil) (All)	0
Total	127

Hole Size Constraint (Min=1mil) (Max=100mil) (All)	
Hole Size Constraint: (106.299mil > 100mil) Pad Free-(-118.111mil,118.11mil) on Multi-Layer Actual Hole Size = 106.299mi	
Hole Size Constraint: (106.299mil > 100mil) Pad Free-(-118.111mil,4242.299mil) on Multi-Layer Actual Hole Size = 106.299mil	
Hole Size Constraint: (106.299mil > 100mil) Pad Free-(-3346.457mil,1604.504mil) on Multi-Layer Actual Hole Size = 106.299mil	
Hole Size Constraint: (106.299mil > 100mil) Pad Free-(-3346.457mil,620.252mil) on Multi-Layer Actual Hole Size = 106.299mil	
Hole Size Constraint: (106.299mil > 100mil) Pad Free-(-4527.559mil,1604.504mil) on Multi-Layer Actual Hole Size = 106.299mil	
Hole Size Constraint: (106.299mil > 100mil) Pad Free-(-4527.559mil,620.252mil) on Multi-Layer Actual Hole Size = 106.299mil	
Hole Size Constraint: (106.299mil > 100mil) Pad Free-(-8385.827mil,117.961mil) on Multi-Layer Actual Hole Size = 106.299mil	
Hole Size Constraint: (106.299mil > 100mil) Pad Free-(-8385.827mil,4242.299mil) on Multi-Layer Actual Hole Size = 106.299mil	
Hole Size Constraint: (255.905mil > 100mil) Pad K1-1(-7916.969mil,671.433mil) on Multi-Layer Actual Slot Hole Height = 255.905mi	
Hole Size Constraint: (255.905mil > 100mil) Pad K1-2(-7916.969mil,1277.732mil) on Multi-Layer Actual Slot Hole Height = 255.905mil	
Hole Size Constraint: (255.905mil > 100mil) Pad K1-3(-7170.906mil,669.465mil) on Multi-Layer Actual Slot Hole Height = 255.905mi	
Hole Size Constraint: (255.905mil > 100mil) Pad K1-4(-7170.906mil,1279.701mil) on Multi-Layer Actual Slot Hole Height = 255.905mil	

Minimum Solder Mask Sliver (Gap=10mil) (All),(All)
Minimum Solder Mask Sliver Constraint: (4.145mil < 10mil) Between Pad P1-(-4409.449mil,1419.464mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (4.145mil < 10mil) Between Pad P1-(-4409.449mil,805.291mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (1.842mil < 10mil) Between Pad Q1-1(-5666.198mil,727.228mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (1.843mil < 10mil) Between Pad Q1-2(-5666.198mil,752.819mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (1.843mil < 10mil) Between Pad Q1-3(-5666.198mil,778.409mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (7.945mil < 10mil) Between Pad Q1-3(-5666.198mil,778.409mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (1.843mil < 10mil) Between Pad Q1-4(-5739.032mil,778.409mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (1.843mil < 10mil) Between Pad Q1-4(-5739.032mil,778.409mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (7.945mil < 10mil) Between Pad Q1-4(-5739.032mil,778.409mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (1.842mil < 10mil) Between Pad Q1-5(-5739.032mil,752.819mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (7.354mil < 10mil) Between Pad Q1-7(-5702.615mil,741.008mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (7.669mil < 10mil) Between Pad R13-1(-7827.756mil,1985.409mil) on Top Layer And Via
Minimum Solder Mask Sliver Constraint: (4.559mil < 10mil) Between Pad R48-1(-2785.591mil,790.501mil) on Top Layer And Via (-2731.3mil,774.74mil)
Minimum Solder Mask Sliver Constraint: (5.78mil < 10mil) Between Pad U10-1(-5476.378mil,2997.22mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (5.779mil < 10mil) Between Pad U10-2(-5513.78mil,2997.22mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (3.631mil < 10mil) Between Pad U3-10(-5349.269mil,1761.984mil) on Top Layer And Via
Minimum Solder Mask Sliver Constraint: (5.935mil < 10mil) Between Pad U3-9(-5349.269mil,1742.299mil) on Top Layer And Via
Minimum Solder Mask Sliver Constraint: (5.78mil < 10mil) Between Pad U5-1(-8026.969mil,3042.732mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (5.779mil < 10mil) Between Pad U5-2(-8064.37mil,3042.732mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (5.78mil < 10mil) Between Pad U6-1(-3250mil,2997.22mil) on Top Layer And Pad U6-2(-3287.402mil,2997.22mil)
Minimum Solder Mask Sliver Constraint: (5.779mil < 10mil) Between Pad U6-2(-3287.402mil,2997.22mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (5.78mil < 10mil) Between Pad U7-1(-2884.843mil,2997.22mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (5.779mil < 10mil) Between Pad U7-2(-2922.244mil,2997.22mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (5.78mil < 10mil) Between Pad U8-1(-5842.323mil,2997.22mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (5.779mil < 10mil) Between Pad U8-2(-5879.725mil,2997.22mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (5.78mil < 10mil) Between Pad U9-1(-673.229mil,2992.299mil) on Top Layer And Pac
Minimum Solder Mask Sliver Constraint: (5.779mil < 10mil) Between Pad U9-2(-710.63mil,2992.299mil) on Top Layer And Pac

Silk To Solder Mask (Clearance=10mil) (IsPad),(All)
Silk To Solder Mask Clearance Constraint: (7.874mil < 10mil) Between Pad C1-1(-6130.938mil,1124.268mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (7.874mil < 10mil) Between Pad C1-1(-6130.938mil,1124.268mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (Collision < 10mil) Between Pad C11-1(-5956.356mil,1761.984mil) on Top Layer And Text "R18"
Silk To Solder Mask Clearance Constraint: (7.874mil < 10mil) Between Pad C1-2(-6130.938mil,1356.551mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (7.874mil < 10mil) Between Pad C1-2(-6130.938mil,1356.551mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (8.995mil < 10mil) Between Pad C15-1(-5842.323mil,2739.74mil) on Top Layer And Text "C15"
Silk To Solder Mask Clearance Constraint: (7.941mil < 10mil) Between Pad C15-2(-5842.323mil,2686.59mil) on Top Layer And Text "C15"
Silk To Solder Mask Clearance Constraint: (Collision < 10mil) Between Pad C52-1(-5023.425mil,1847.614mil) on Top Layer And Text "TP24"
Silk To Solder Mask Clearance Constraint: (9.475mil < 10mil) Between Pad C6-2(-5023.425mil,685.213mil) on Top Layer And Text "C6"
Silk To Solder Mask Clearance Constraint: (9.655mil < 10mil) Between Pad C7-1(-8346.457mil,1965.724mil) on Top Layer And Text "C7"
Silk To Solder Mask Clearance Constraint: (9.7mil < 10mil) Between Pad C7-2(-8346.457mil,1912.575mil) on Top Layer And Text "C7"
Silk To Solder Mask Clearance Constraint: (Collision < 10mil) Between Pad C8-1(-5349.269mil,1613.984mil) on Top Layer And Text "U3"
Silk To Solder Mask Clearance Constraint: (Collision < 10mil) Between Pad C8-2(-5349.269mil,1560.835mil) on Top Layer And Text "U3"
Silk To Solder Mask Clearance Constraint: (6.535mil < 10mil) Between Pad D1-1(-6122.047mil,741.992mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (6.535mil < 10mil) Between Pad D1-1(-6122.047mil,741.992mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (6.535mil < 10mil) Between Pad D1-2(-6122.047mil,899.472mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (6.535mil < 10mil) Between Pad D1-2(-6122.047mil,899.472mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (9.724mil < 10mil) Between Pad D2-2(-5502.812mil,755.002mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (8.213mil < 10mil) Between Pad LED1-2(-5982.284mil,738.363mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (8.213mil < 10mil) Between Pad LED2-2(-6296.634mil,1624.189mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (8.213mil < 10mil) Between Pad LED3-2(-3051.181mil,1013.953mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (8.4mil < 10mil) Between Pad P10-0(-6216.536mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P10-0(-6216.536mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (7.053mil < 10mil) Between Pad P10-0(-6925.197mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P10-0(-6925.197mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (8.78mil < 10mil) Between Pad P1-1(-4338.583mil,1348.597mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (8.4mil < 10mil) Between Pad P11-0(-4539.37mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P11-0(-4539.37mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (7.053mil < 10mil) Between Pad P11-0(-5248.032mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P11-0(-5248.032mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (8.4mil < 10mil) Between Pad P12-0(-3618.11mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P12-0(-3618.11mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (7.053mil < 10mil) Between Pad P12-0(-4326.772mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P12-0(-4326.772mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (8.767mil < 10mil) Between Pad P1-25(-4338.583mil,876.157mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (9.4mil < 10mil) Between Pad P1-26(-4480.315mil,876.157mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (8.4mil < 10mil) Between Pad P13-0(-1937.992mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P13-0(-1937.992mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (7.053mil < 10mil) Between Pad P13-0(-2646.654mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P13-0(-2646.654mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P14-0(-1019.685mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (8.4mil < 10mil) Between Pad P14-0(-1019.685mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (7.053mil < 10mil) Between Pad P14-0(-1728.347mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P14-0(-1728.347mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P15-0(-2482.677mil,1151.748mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.918mil < 10mil) Between Pad P15-0(-2482.677mil,1151.748mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P15-0(-2482.677mil,561.197mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (7.376mil < 10mil) Between Pad P15-0(-2482.677mil,561.197mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.401mil < 10mil) Between Pad P1-50(-4480.315mil,1348.597mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (8.4mil < 10mil) Between Pad P3-0(-6484.827mil,897.11mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P3-0(-6484.827mil,897.11mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (7.053mil < 10mil) Between Pad P3-0(-6721.048mil,897.11mil) on Multi-Layer And Track

Silk To Solder Mask (Clearance=10mil) (IsPad),(All)

Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P3-0(-6721.048mil,897.11mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (8.4mil < 10mil) Between Pad P9-0(-7137.795mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P9-0(-7137.795mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (7.053mil < 10mil) Between Pad P9-0(-7846.457mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (9.281mil < 10mil) Between Pad P9-0(-7846.457mil,3217.89mil) on Multi-Layer And Track
Silk To Solder Mask Clearance Constraint: (1.969mil < 10mil) Between Pad Q1-1(-5666.198mil,727.228mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (4.415mil < 10mil) Between Pad Q1-2(-5666.198mil,752.819mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (4.415mil < 10mil) Between Pad Q1-2(-5666.198mil,752.819mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (1.969mil < 10mil) Between Pad Q1-3(-5666.198mil,778.409mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (1.969mil < 10mil) Between Pad Q1-4(-5739.032mil,778.409mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (4.415mil < 10mil) Between Pad Q1-5(-5739.032mil,752.819mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (4.415mil < 10mil) Between Pad Q1-5(-5739.032mil,752.819mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (1.969mil < 10mil) Between Pad Q1-6(-5739.032mil,727.228mil) on Top Layer And Track
Silk To Solder Mask Clearance Constraint: (7.68mil < 10mil) Between Pad R16-1(-5121.654mil,1624.189mil) on Top Layer And Text "R17"
Silk To Solder Mask Clearance Constraint: (Collision < 10mil) Between Pad R16-2(-5182.677mil,1624.189mil) on Top Layer And Text "R17"
Silk To Solder Mask Clearance Constraint: (Collision < 10mil) Between Pad R17-1(-5121.654mil,1683.244mil) on Top Layer And Text "R16"
Silk To Solder Mask Clearance Constraint: (Collision < 10mil) Between Pad R17-2(-5182.677mil,1683.244mil) on Top Layer And Text "R16"
Silk To Solder Mask Clearance Constraint: (2.51mil < 10mil) Between Pad R28-2(-6437.008mil,2223.598mil) on Top Layer And Text "U23"
Silk To Solder Mask Clearance Constraint: (9.584mil < 10mil) Between Pad R38-2(-1122.047mil,2243.283mil) on Top Layer And Text "U27"
Silk To Solder Mask Clearance Constraint: (9.791mil < 10mil) Between Pad U13-1(-7922.111mil,2785.606mil) on Top Layer And Text "C57"
Silk To Solder Mask Clearance Constraint: (9.797mil < 10mil) Between Pad U13-2(-7922.111mil,2765.921mil) on Top Layer And Text "C57"
Silk To Solder Mask Clearance Constraint: (9.965mil < 10mil) Between Pad U26-7(-5073.425mil,1930.291mil) on Top Layer And Text "C52"
Silk To Solder Mask Clearance Constraint: (9.921mil < 10mil) Between Pad U26-8(-5023.425mil,1930.291mil) on Top Layer And Text "C52"
Silk To Solder Mask Clearance Constraint: (Collision < 10mil) Between Pad U3-6(-5349.269mil,1683.244mil) on Top Layer And Text "C8"
Silk To Solder Mask Clearance Constraint: (Collision < 10mil) Between Pad U3-7(-5349.269mil,1702.929mil) on Top Layer And Text "C8"

Silk to Silk (Clearance=10mil) (All),(All)

Silk To Silk Clearance Constraint: (7.806mil < 10mil) Between Text "1" (-2783.465mil,683.244mil) on Top Overlay And Track
Silk To Silk Clearance Constraint: (3.858mil < 10mil) Between Text "1" (-6610.811mil,954.591mil) on Top Overlay And Track
Silk To Silk Clearance Constraint: (7.795mil < 10mil) Between Text "5" (-1633.858mil,3279.307mil) on Top Overlay And Track
Silk To Silk Clearance Constraint: (7.795mil < 10mil) Between Text "5" (-2552.165mil,3279.307mil) on Top Overlay And Track
Silk To Silk Clearance Constraint: (7.795mil < 10mil) Between Text "5" (-4232.283mil,3279.307mil) on Top Overlay And Track
Silk To Silk Clearance Constraint: (7.795mil < 10mil) Between Text "5" (-5153.543mil,3279.307mil) on Top Overlay And Track
Silk To Silk Clearance Constraint: (7.795mil < 10mil) Between Text "5" (-6830.709mil,3279.307mil) on Top Overlay And Track
Silk To Silk Clearance Constraint: (7.795mil < 10mil) Between Text "5" (-7751.968mil,3279.307mil) on Top Overlay And Track
Silk To Silk Clearance Constraint: (7.795mil < 10mil) Between Text "8" (-2421.26mil,1041.512mil) on Top Overlay And Track
Silk To Silk Clearance Constraint: (6.423mil < 10mil) Between Text "C46" (-6299.695mil,1650.657mil) on Top Overlay And Track
Silk To Silk Clearance Constraint: (9.714mil < 10mil) Between Text "C8" (-5379.536mil,1662mil) on Top Overlay And Track